# SQJ147ELP

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# Automotive P-Channel 40 V (D-S) 175 °C MOSFET

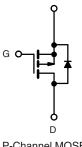


PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.0125			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.018			
I <sub>D</sub> (A)	-90			
Configuration	Single			
Package	PowerPAK SO-8L			

### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>





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P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-40	V	
Gate-source voltage <sup>a</sup>		V <sub>GS</sub>	± 20	v	
Continuous drain current	$T_C = 25 \ ^{\circ}C \ ^{b}$	I_	-90		
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	-52		
Continuous source current (diode conduction) <sup>b</sup>		I <sub>S</sub>	-90	А	
Pulsed drain current <sup>c</sup>		I <sub>DM</sub>	-200		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	-41		
Single pulse avalanche energy	L = 0.1 mm	E <sub>AS</sub>	45	mJ	
Maximum power dissipation <sup>c</sup>	T <sub>C</sub> = 25 °C	PD	183	W	
	T <sub>C</sub> = 125 °C	гD	61	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount <sup>f</sup>	R <sub>thJA</sub>	46	°C/W		
Junction-to-case (drain)		R <sub>thJC</sub>	0.82	0/10		

### Notes

- a. Not intended for continuous use with positive gate voltage > 5.0 V
- b. Package limited
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = -250 \ \mu A$		-40	-	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		-2.0	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = -40 V	-	-	-1	μΑ	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = -40 V, T <sub>J</sub> = 125 °C	-	-	-50		
		$V_{GS} = 0 V$	V <sub>DS</sub> = -40 V, T <sub>J</sub> = 175 °C	-	-	-150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -10 V	$V_{DS} \ge -5 V$	-30	-	-	А	
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A	-	0.01	0.0125		
Drain aguras an stata registence à	Р	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 125 °C	-	-	0.019	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	l <sub>D</sub> = -10 A, T <sub>J</sub> = 175 °C	-	-	0.023		
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -8 A	-	0.0144	0.018	1	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> =	-	45	-	S		
Dynamic <sup>b</sup>								
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = -25 V, f = 1 MHz	-	4225	5500	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	305	400		
Reverse transfer capacitance	C <sub>rss</sub>				281	365	1	
Total gate charge <sup>c</sup>	Qg			-	85	120		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V	V <sub>GS</sub> = -10 V V <sub>DS</sub> = -20 V, I <sub>D</sub> = -10 A		14.5	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>				14.8	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		1.7	3.9	6.2	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	12	18		
Rise time <sup>c</sup>	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD} = -20 \ V, \ R_L = 2 \ \Omega, \\ I_D \cong -10 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega \end{array}$		-	4	6	- ns	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	66	99		
Fall time <sup>c</sup>	t <sub>f</sub>			-	16	24		
Source-Drain Diode Ratings and Charac	cteristics <sup>b</sup>							
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-200	А	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V		-	-0.76	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = -10 A, di/dt = 100 A/μs		-	20	40	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	14	28	nC	
Reverse recovery fall time	ta			-	11	-	ns	
Reverse recovery rise time	t <sub>b</sub>			-	8	-		
Body diode peak reverse recovery					1		1	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

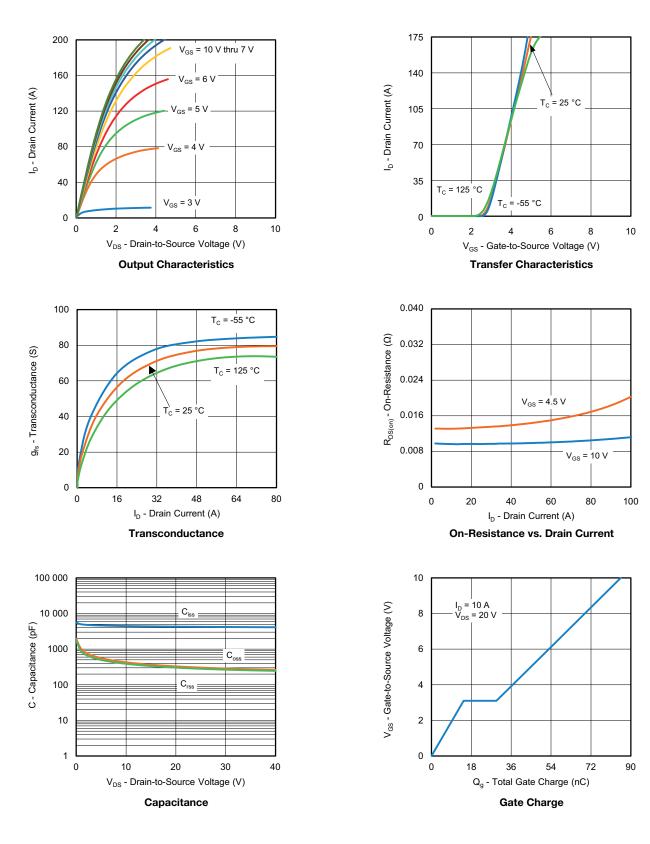
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



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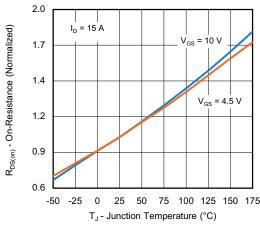
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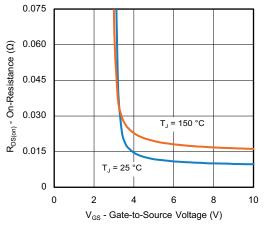
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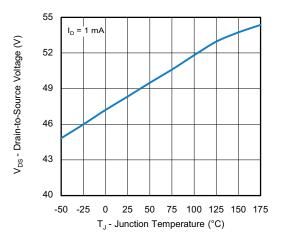
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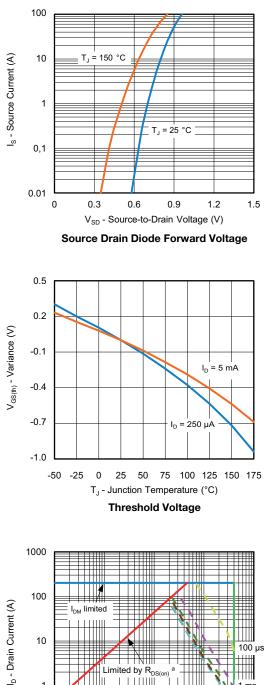
**On-Resistance vs. Junction Temperature** 

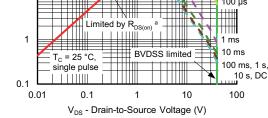


On-Resistance vs. Gate-to-Source Voltage

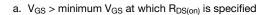


Drain-Source Breakdown vs. Junction Temperature





Safe Operating Area



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Note

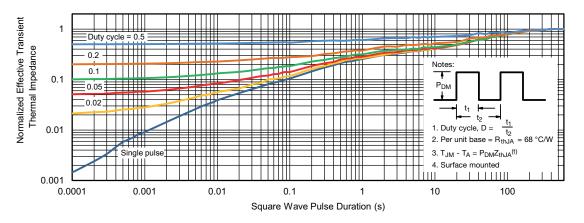
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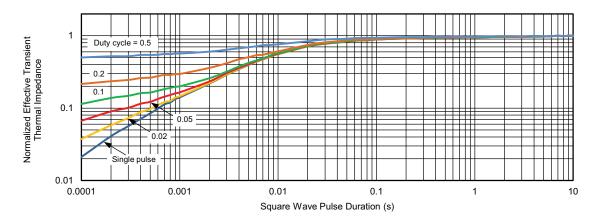


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### THERMAL RATINGS (T<sub>C</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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